

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6371103

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
XING LIU	03/06/2020
WEI SHAN	03/06/2020
JIAN WANG	03/06/2020
RECEIVING PARTY DATA	
Name:	SABIC GLOBAL TECHNOLOGIES B.V.
Street Address:	PLASTICSLAAN 1
City:	BERGEN OP ZOOM
State/Country:	NETHERLANDS
Postal Code:	4612 PX
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17081734
CORRESPONDENCE DATA	
Fax Number:	(860)286-0115
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	8602862929
Email:	abell@cantorcolburn.com , usptopatentmail@cantorcolburn.com
Correspondent Name:	CANTOR COLBURN LLP
Address Line 1:	20 CHURCH STREET
Address Line 2:	22ND FLOOR
Address Line 4:	HARTFORD, CONNECTICUT 06103
ATTORNEY DOCKET NUMBER:	19PLAS0135-US-NP
NAME OF SUBMITTER:	KIMBERLY K. VINES
SIGNATURE:	/Kimberly K. Vines/
DATE SIGNED:	10/27/2020
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 3	
source=8HZ3871#page1.tif	
source=8HZ3932#page1.tif	

ASSIGNMENT

Title of Invention: **THERMOPLASTIC COMPOSITIONS WITH IMPROVED HYDROLYTIC STABILITY AND ELECTRICAL TRACKING RESISTANCE AND THE SHAPED ARTICLE THEREFORE**

This Assignment is directed to:

☒ the application having Attorney Docket Number 19PLAS0135-EP-EPA, or

☒ EP patent application number 20152445.1 filed on January 17, 2020.

☐ which claims priority to Patent application number _____ filed on _____.

Whereas, each undersigned inventor has made certain inventions, improvements, and discoveries (herein referred to as the "INVENTION") disclosed in the above-identified patent application (herein referred to as the "APPLICATION");

Whereas, SABIC Global Technologies B.V., a corporation of The Netherlands having a place of business at Plasticslaan 1, 4612 PX Bergen op Zoom, The Netherlands (herein referred to as "ASSIGNEE") desires to acquire or has acquired, and each undersigned inventor acknowledges the obligation to assign to ASSIGNEE, and the parties desire to use this Assignment to memorialize the grant to ASSIGNEE of the entire worldwide right, title, and interest in and to the INVENTION including all embodiments thereof, and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor (herein referred to as "ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to the ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the INVENTION, the APPLICATION, and any and all other patent applications and patents for the INVENTION which may be applied for or granted therefor in any and all countries and jurisdictions, including all priority applications, nonprovisionals, divisions, continuations, continuations-in-part, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents; and any and all claims and causes of action, with respect to any of the foregoing, whether accruing before, on and/or after the date hereof, including all rights to and claims for damages, restitution and injunctive and other legal and equitable relief for past, present and future infringement, dilution, misappropriation, violation, misuse, breach or default, with the right but no obligation to sue for such legal and equitable relief and to collect, or otherwise recover, any such damages. In addition, each undersigned inventor hereby authorizes and requests any official whose duty it is to issue patents, to issue any patent on the INVENTION or from the APPLICATION to said ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees on behalf of themselves, their successors and legal representatives, to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the INVENTION, the APPLICATION, and all related patents and applications, in ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by ASSIGNEE, its successors, legal representatives, and assigns.

Each undersigned inventor also hereby grants ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification of the APPLICATION (including, but not limited to, Application Number and filing date, and Attorney Docket Numbers), and further grants ASSIGNEE, its successors, legal representatives, and assigns the right to execute confirmatory assignments on their behalf.

Signature: Jian Wang
Name of Inventor: JIAN WANG

Date: 2020.03.06

First Witness: Qin Wang
Printed Name: QIN WANG

Date: 2020.3.6

Second Witness: Huibai Li
Printed Name: Huibai Li

Date: 2020.3.6

ASSIGNMENT

Title of Invention: **THERMOPLASTIC COMPOSITIONS WITH IMPROVED HYDROLYTIC STABILITY AND ELECTRICAL TRACKING RESISTANCE AND THE SHAPED ARTICLE THEREFORE**

This Assignment is directed to:

- ☒ the application having Attorney Docket Number 19PLAS0135-EP-EPA, or
☒ EP patent application number 20152445.1 filed on January 17, 2020.
☐ which claims priority to Patent application number _____ filed on _____.

Whereas, each undersigned inventor has made certain inventions, improvements, and discoveries (herein referred to as the "INVENTION") disclosed in the above-identified patent application (herein referred to as the "APPLICATION");

Whereas, SABIC Global Technologies B.V., a corporation of The Netherlands having a place of business at Plasticlaan 1, 4612 PX Bergen op Zoom, The Netherlands (herein referred to as "ASSIGNEE") desires to acquire or has acquired, and each undersigned inventor acknowledges the obligation to assign to ASSIGNEE, and the parties desire to use this Assignment to memorialize the grant to ASSIGNEE of the entire worldwide right, title, and interest in and to the INVENTION including all embodiments thereof, and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor (herein referred to as "ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to the ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the INVENTION, the APPLICATION, and any and all other patent applications and patents for the INVENTION which may be applied for or granted therefor in any and all countries and jurisdictions, including all priority applications, nonprovisionals, divisions, continuations, continuations-in-part, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents; and any and all claims and causes of action, with respect to any of the foregoing, whether accruing before, on and/or after the date hereof, including all rights to and claims for damages, restitution and injunctive and other legal and equitable relief for past, present and future infringement, dilution, misappropriation, violation, misuse, breach or default, with the right but no obligation to sue for such legal and equitable relief and to collect, or otherwise recover, any such damages. In addition, each undersigned inventor hereby authorizes and requests any official whose duty it is to issue patents, to issue any patent on the INVENTION or from the APPLICATION to said ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees on behalf of themselves, their successors and legal representatives, to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the INVENTION, the APPLICATION, and all related patents and applications, in ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by ASSIGNEE, its successors, legal representatives, and assigns.

Each undersigned inventor also hereby grants ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification of the APPLICATION (including, but not limited to, Application Number and filing date, and Attorney Docket Numbers), and further grants ASSIGNEE, its successors, legal representatives, and assigns the right to execute confirmatory assignments on their behalf.

Signature: Wei Shan
 Name of Inventor: WEI SHAN

Date: 2020.3.6

First Witness: SONG SHIJE
 Printed Name: SONG SHIJE

Date: 2020.3.6

Second Witness: Huohui Li
 Printed Name: Huohui Li

Date: 2020.3.6

ASSIGNMENT

Title of Invention: **THERMOPLASTIC COMPOSITIONS WITH IMPROVED HYDROLYTIC STABILITY AND ELECTRICAL TRACKING RESISTANCE AND THE SHAPED ARTICLE THEREFORE**

This Assignment is directed to:

☒ the application having Attorney Docket Number 19PLAS0135-EP-EPA, or

☒ EP patent application number 20152445.1 filed on January 17, 2020.

☐ which claims priority to Patent application number _____ filed on _____

Whereas, each undersigned inventor has made certain inventions, improvements, and discoveries (herein referred to as the "INVENTION") disclosed in the above-identified patent application (herein referred to as the "APPLICATION");

Whereas, SABIC Global Technologies B.V., a corporation of The Netherlands having a place of business at Plasticslaan 1, 4612 PX Bergen op Zoom, The Netherlands (herein referred to as "ASSIGNEE") desires to acquire or has acquired, and each undersigned inventor acknowledges the obligation to assign to ASSIGNEE, and the parties desire to use this Assignment to memorialize the grant to ASSIGNEE of the entire worldwide right, title, and interest in and to the INVENTION including all embodiments thereof, and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, each undersigned inventor (herein referred to as "ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to the ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the INVENTION, the APPLICATION, and any and all other patent applications and patents for the INVENTION which may be applied for or granted therefor in any and all countries and jurisdictions, including all priority applications, nonprovisionals, divisions, continuations, continuations-in-part, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents; and any and all claims and causes of action, with respect to any of the foregoing, whether accruing before, on and/or after the date hereof, including all rights to and claims for damages, restitution and injunctive and other legal and equitable relief for past, present and future infringement, dilution, misappropriation, violation, misuse, breach or default, with the right but no obligation to sue for such legal and equitable relief and to collect, or otherwise recover, any such damages. In addition, each undersigned inventor hereby authorizes and requests any official whose duty it is to issue patents, to issue any patent on the INVENTION or from the APPLICATION to said ASSIGNEE, its successors, legal representatives, and assigns, the entire worldwide right, title, and interest in and to the same to be held and enjoyed by ASSIGNEE, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made; and each undersigned inventor agrees on behalf of themselves, their successors and legal representatives, to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the INVENTION, the APPLICATION, and all related patents and applications, in ASSIGNEE, its successors, legal representatives, and assigns, whenever requested by ASSIGNEE, its successors, legal representatives, and assigns.

Each undersigned inventor also hereby grants ASSIGNEE, its successors, legal representatives, and assigns, the right to insert in this Assignment any further identification of the APPLICATION (including, but not limited to, Application Number and filing date, and Attorney Docket Numbers), and further grants ASSIGNEE, its successors, legal representatives, and assigns the right to execute confirmatory assignments on their behalf.

Signature: Xing Liu
Name of Inventor: XING LIU

Date: 2020.3.6

First Witness: Qin Wang
Printed Name: Qin WANG

Date: 2020.3.6

Second Witness: Huihui Li
Printed Name: Huihui Li

Date: 2020.3.6